PCN # 2032

DATE: March 19, 2020

EXPECTED PCN SHIP DATE: March 19, 2020



**Quality Assurance** 160 Rio Robles San Jose, CA 95134

www.maximintegrated.com

	PROCESS CHANGE NOTICE
X	PRODUCT CHANGE NOTICE

		PROCESS (	CHANGE	NOTICE				
		X PRODUCT	CHANGE	NOTICE				
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X DESIGN	THAT M  WAFER FAB	AY AFFECT THE I		G CATEGORI TEST	IES:   X  ELEC/MECH SPECS			
	Orde	ring P/N: (See PN lis	PRODUCT					
	Orde	ing 1/11. (See 111 in	sting ALD in	Terven ine)				
CHANGE FROM	1: Design/Datasheet Change	s/Microcontrollers	CHANGE '	ТО: -				
MAX32665,MAX	X32666,MAX32667,MAX32	2668						
1. Current DieID	CCI7)	1. New DieID/Die revision (ME14A-0C/CGD8)						
1	Mode/IREGI_BK	2. Backup currents have been reduced by 6uA						
(current datashee								
3. DeepSleep Current: VREGI Fixed Current, DeepSleep			3. The Deep Sleep current has been reduced to 10uA typical					
Mode/IREGI_FD	OSL (from 23.2uA typical)							
JUSTIFICATION								
ļ		age current on SIMO	O (Single-Inc	luctor Multiple	e-Output) switches, enabling the support			
l .	of BLE and non-BLE designs with lower backup and deepsleep (standby) currents.							
There are no other changes to form/fit/function of the devices.								
BLE: Bluetooth I	Low Energy							
TRACEABILITY	Y: Maxim Integrated maintai	ns full traceability by	y device mar	king, packagin	ng labels and shipment documents.			
Maxim Integrated facility improvem		em is designed to ke	ep our custo	mer base appri	ised of major product, manufacturing, or			
				Nasse	er Ali Chronche			
				Nasser	AliChaouche / PCN Coordinator			
For further inform	nation, please contact either	of the people listed b	oelow.					
Contact your loc	cal Maxim Integrated Com	pany Representativ	e or	Nasser AliC	Chaouche, PCN Coordinator			
•				(0 / 1 6 6 1				

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